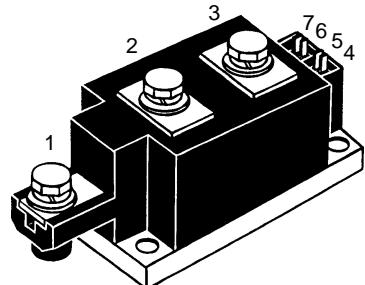
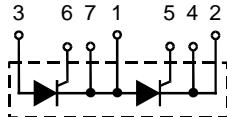


# Thyristor Modules

## Thyristor/Diode Modules

**I<sub>TRMS</sub> = 2x 350 A**  
**I<sub>TAVM</sub> = 2x 203 A**  
**V<sub>RRM</sub> = 1200-1800 V**

V <sub>RSM</sub> V <sub>DSM</sub> V	V <sub>RRM</sub> V <sub>DRM</sub> V	Type
1300	1200	MCC 170-12io1
1500	1400	MCC 170-14io1
1700	1600	MCC 170-16io1
1900	1800	MCC 170-18io1



Symbol	Test Conditions	Maximum Ratings			Features
I <sub>TRMS</sub>	T <sub>VJ</sub> = T <sub>VJM</sub>	350	A		• International standard package
I <sub>TAVM</sub>	T <sub>C</sub> = 85°C; 180° sine	203	A		• Direct copper bonded Al <sub>2</sub> O <sub>3</sub> -ceramic with copper base plate
I <sub>TSM</sub> , I <sub>FSM</sub>	T <sub>VJ</sub> = 45°C; V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	5400 5800	A A	• Planar passivated chips
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	5000 5500	A A	• Isolation voltage 3600 V~
j <sup>2</sup> dt	T <sub>VJ</sub> = 45°C V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	146 000 140 000	A <sup>2</sup> s A <sup>2</sup> s	• UL registered E 72873
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	125 000 126 000	A <sup>2</sup> s A <sup>2</sup> s	• Keyed gate/cathode twin pins
(di/dt) <sub>cr</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> f = 50 Hz, t <sub>p</sub> = 200 μs V <sub>D</sub> = 2/3 V <sub>DRM</sub> I <sub>G</sub> = 1 A, di <sub>G</sub> /dt = 1 A/μs	repetitive, I <sub>T</sub> = 660 A  non repetitive, I <sub>T</sub> = I <sub>TAVM</sub>	100 500	A/μs A/μs	
(dv/dt) <sub>cr</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> ; V <sub>DR</sub> = 2/3 V <sub>DRM</sub> R <sub>GK</sub> = ∞; method 1 (linear voltage rise)		1000	V/μs	
P <sub>GM</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> I <sub>T</sub> = I <sub>TAVM</sub>	t <sub>p</sub> = 30 μs t <sub>p</sub> = 500 μs	120 60 20 10	W W W V	
P <sub>GAV</sub>			-40...+130	°C	
V <sub>RGM</sub>			130	°C	
T <sub>VJ</sub>			-40...+125	°C	
T <sub>VJM</sub>					
T <sub>stg</sub>					
V <sub>ISOL</sub>	50/60 Hz, RMS	t = 1 min	3000	V~	
	I <sub>ISOL</sub> ≤ 1 mA	t = 1 s	3600	V~	
M <sub>d</sub>	Mounting torque (M6)		4.5-7/40-62	Nm/lb.in.	
	Terminal connection torque (M8)		11-13/97-115	Nm/lb.in.	
Weight	Typical including screws		750	g	

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.  
 IXYS reserves the right to change limits, test conditions and dimensions

Symbol	Test Conditions	Characteristic Values	
$I_{RRM}, I_{DRM}$	$T_{VJ} = T_{VJM}; V_R = V_{RRM}; V_D = V_{DRM}$	40	mA
$V_T, V_F$	$I_T, I_F = 600 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.65	V
$V_{TO}$	For power-loss calculations only ( $T_{VJ} = 130^\circ\text{C}$ )	0.8	V
$r_T$		1	$\text{m}\Omega$
$V_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$	2	V
	$T_{VJ} = -40^\circ\text{C}$	3	V
$I_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$	150	mA
	$T_{VJ} = -40^\circ\text{C}$	220	mA
$V_{GD}$	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	0.25	V
$I_{GD}$	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	10	mA
$I_L$	$T_{VJ} = 25^\circ\text{C}; t_p = 30 \mu\text{s}; V_D = 6 \text{ V}$ $I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$	200	mA
$I_H$	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	150	mA
$t_{gd}$	$T_{VJ} = 25^\circ\text{C}; V_D = 1/2 V_{DRM}$ $I_G = 1 \text{ A}; di_G/dt = 1 \text{ A}/\mu\text{s}$	2	$\mu\text{s}$
$t_q$	$T_{VJ} = T_{VJM}; I_T = 300 \text{ A}, t_p = 200 \mu\text{s}; -di/dt = 10 \text{ A}/\mu\text{s}$ $V_R = 100 \text{ V}; dv/dt = 50 \text{ V}/\mu\text{s}; V_D = 2/3 V_{DRM}$	typ.	200 $\mu\text{s}$
$Q_s$	$T_{VJ} = 125^\circ\text{C}; I_T, I_F = 300 \text{ A}; -di/dt = 50 \text{ A}/\mu\text{s}$	550	$\mu\text{C}$
$I_{RM}$		235	A
$R_{thJC}$	per thyristor (diode); DC current	0.164	K/W
	per module	0.082	K/W
$R_{thJK}$	per thyristor (diode); DC current	0.204	K/W
	per module	0.102	K/W
$d_s$	Creeping distance on surface	12.7	mm
$d_A$	Creepage distance in air	9.6	mm
$a$	Maximum allowable acceleration	50	$\text{m}/\text{s}^2$

Optional accessories for modules

Keyed Gate/Cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

Type **ZY 180 L** (L = Left for pin pair 4/5)      } UL 758, style 1385,

Type **ZY 180 R** (R = Right for pin pair 6/7)      } CSA class 5851, guide 460-1-1

#### Dimensions in mm (1 mm = 0.0394")

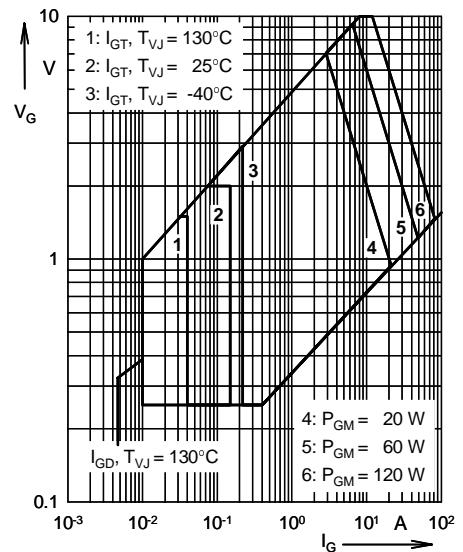
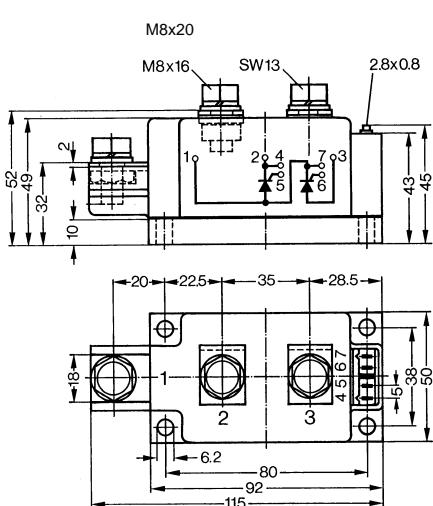


Fig. 1 Gate trigger characteristics

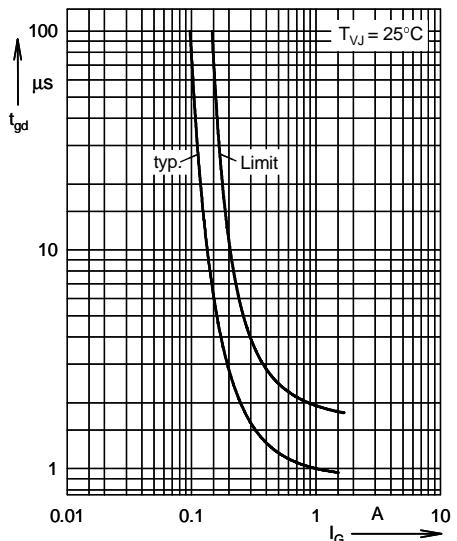


Fig. 2 Gate trigger delay time

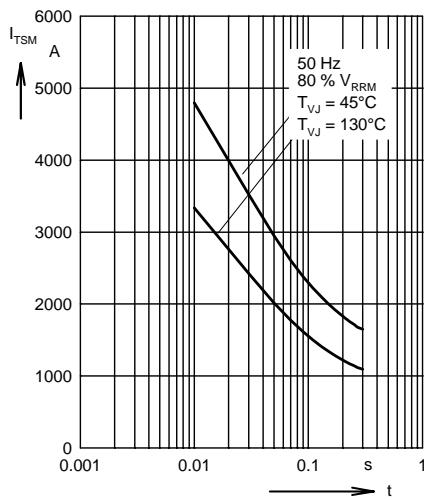


Fig. 3 Surge overload current  
 $I_{TSM}, I_{FSM}$ : Crest value,  $t$ : duration

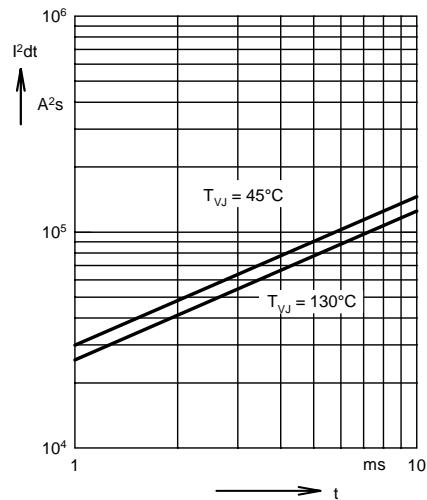


Fig. 4  $\int i^2 dt$  versus time (1-10 ms)

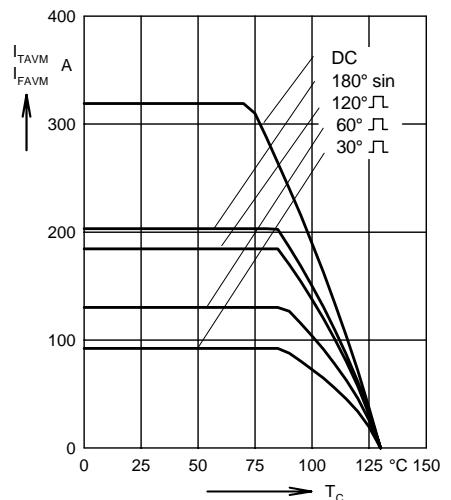


Fig. 4a Maximum forward current at case temperature

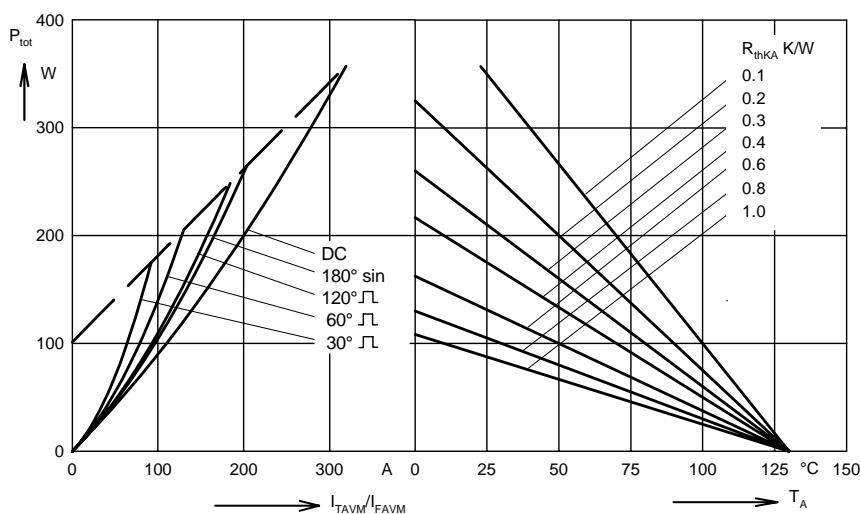


Fig. 5 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

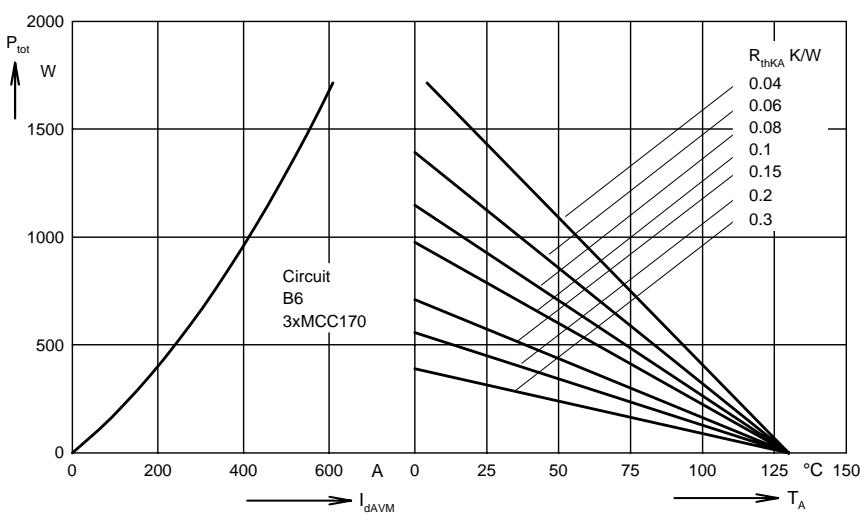


Fig. 6 Three phase rectifier bridge:  
Power dissipation versus direct output current and ambient temperature

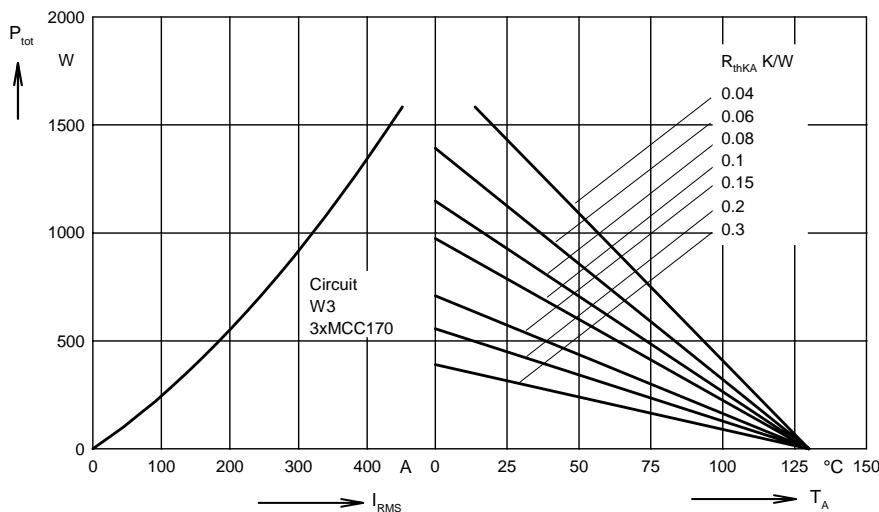


Fig. 7 Three phase AC-controller:  
Power dissipation versus RMS  
output current and ambient  
temperature

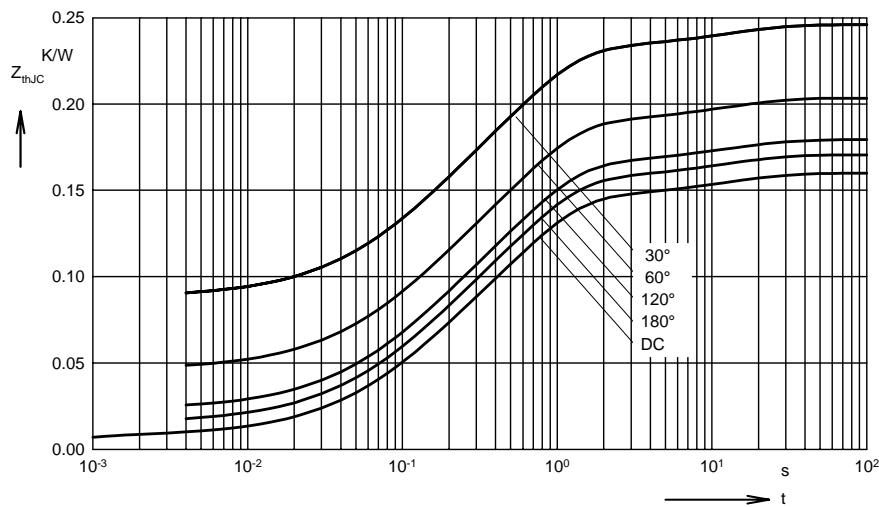


Fig. 8 Transient thermal impedance  
junction to case (per thyristor or  
diode)

$R_{thJC}$  for various conduction angles  $d$ :

$d$	$R_{thJC}$ (K/W)
DC	0.160
180°	0.171
120°	0.180
60°	0.203
30°	0.247

Constants for  $Z_{thJC}$  calculation:

$i$	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0077	0.00054
2	0.0413	0.098
3	0.096	0.54
4	0.0149	12

Fig. 9 Transient thermal impedance  
junction to heatsink (per thyristor or  
diode)

$R_{thJK}$  for various conduction angles  $d$ :

$d$	$R_{thJK}$ (K/W)
DC	0.200
180°	0.211
120°	0.220
60°	0.243
30°	0.287

Constants for  $Z_{thJK}$  calculation:

$i$	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0077	0.00054
2	0.0413	0.098
3	0.096	0.54
4	0.0149	12
5	0.04	12